

End User Computing & Peripherals, Device Lifecycle Management Solutions, and Associated Services MHEC-RFP-10282021 Amendment #1 November 17, 2021

The purpose of this Amendment is to present changes to the End User Computing & Peripherals, Device Lifecycle Management, and Associated Services MHEC-RFP-10282021 dated October 28, 2012. All other terms and conditions of the original RFP are unchanged. Please check MHEC's public website at <a href="http://mhec.org/news">http://mhec.org/news</a> daily. Contact Nathan Sorensen at <a href="mailto:nathans@mhec.org">nathans@mhec.org</a> for questions concerning this Amendment and RFP.

Whereas the following sections ae amended as follows (new information **bold-underlined**, deleted information is strikethrough):

## A.8 PROPOSAL TIMELINE

The following section describes the proposal timeline of events related to this multi-stage Request for Proposal (RFP). Due dates are as indicated unless otherwise changed by MHEC. In the event MHEC finds it necessary to change any of the dates or events listed in this table, it will do so by issuing a written statement or an amendment to the RFP and publicly post the notice at <u>http://www.mhec.org/news</u>.

Event	Date
Formal Issuance of RFP	Thursday, October 28, 2021
Pre-Proposal Questions Due	Wednesday, November 10, 2021, 10:00 A.M. CT
Publish Answers to Pre-Proposal Questions	Tuesday, November 16, 2021
Proposals Due	Tuesday, December 7, 2021, 10:00 A.M. CT Tuesday, December 14, 2021, 10:00 A.M. CT
Notification of Finalist	Friday, January 14, 2022
Respondent's Conference (Virtual)	Wednesday, January 26, 2022; Thursday, January 27, 2022; or Friday, January 28, 2022
Best and Final Offer (BAFO)	February 2022
Contract Award	February 2022
Execution of Agreement	June 2022



## A.11 SUBMISSION REQUIREMENTS AND PROPOSAL DEADLINE

The deadline for submission of proposals and related information is Tuesday, <u>December 14, 2021</u>, December 7, 2021, 10:00 A.M. CT. One (1) sealed bound original, one (1) identical electronic copy of the response, and an electronic copy emailed to <u>nathans@mhec.org</u>. <u>The email submission is acceptable</u> <u>for meeting the deadline</u>. The email submission is not a replacement for sending a sealed bound original copy. Allowable formats are PDF and Microsoft Office. Spreadsheet data such as product and service price lists may be submitted in Microsoft Office Excel format. Proposals delivered late will be rejected.

End User Computing and Peripherals, Device Lifecycle Management Solutions, and Associated Services

MHEC-RFP-10282021 c/o Mr. Nathan Sorensen Midwestern Higher Education Compact 105 Fifth Avenue South, Suite 450, Minneapolis, MN 55401